PRODUCT DATASHEET
LVCOBPFM-009-1203

COBLED PFM 9W 1203

AREAS OF APPLICATION

– Track Light
– Spot Light
– Par Light
– Bulb Light
– Down Light

PRODUCT BENEFITS

– Good consistency of lightcolor,highflux,high efficiency
– Low thermal resistance, good thermal stability
– Strong compatibility,easy to install and use
– High reliability
– LM-80 Certified and applied with RoHS standard
– IEC standards

TECHNICAL DATA

Basic Parameters

Model	CCT	RA Min.	R9 Min.	Luminous Flux(LM) Tj=85°C Min.	Luminous Flux(LM) Tj=85°C Typ.	Luminous Flux(LM) Tj=25°C Typ.	Typ. Lumens (LM/W) Tj=25°C	Typ. Current (mA)	Thermal Resistance Rj (°C/W)
PFM-009-1203-P2780	2700K	80	0	1122	1220	1341	140	270	1.6
PFM-009-1203-P3080	3000K	80	0	1201	1306	1443	151	270	1.6
PFM-009-1203-P3580	3500K	80	0	1261	1338	1487	156	270	1.6
PFM-009-1203-P4080	4000K	80	0	1261	1371	1519	159	270	1.6
PFM-009-1203-P5080	5000K	80	0	1255	1365	1519	159	270	1.6
PFM-009-1203-P6580	6500K	80	0	1243	1352	1502	157	270	1.6
PFM-009-1203-P2790	2700K	90	50	960	1043	1159	121	270	1.6
PFM-009-1203-P3090	3000K	90	50	1021	1110	1233	129	270	1.6
PFM-009-1203-P3590	3500K	90	50	1062	1154	1283	134	270	1.6
PFM-009-1203-P4090	4000K	90	50	1113	1210	1344	141	270	1.6
PFM-009-1203-P5090	5000K	90	50	1108	1204	1338	140	270	1.6
PFM-009-1203-P6590	6500K	90	50	1098	1193	1326	139	270	1.6

Device tolerance

- For luminous flux:±7%
- Voltage±5%
- device tolerance for color coordinate:±0.002
- Ra/R9±2

TECHNICAL DATA

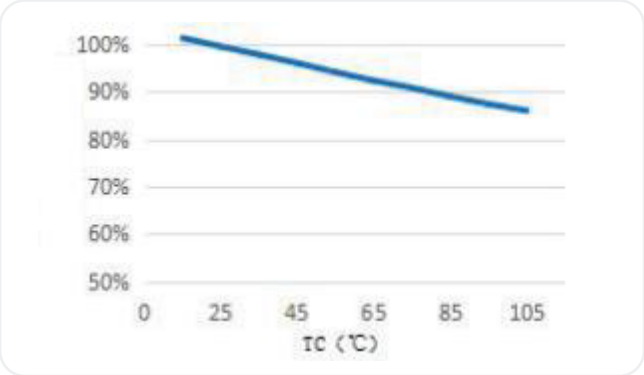
Limit Parameters

Parameters	Symbol	Min	Typ	Max	Unit
Forwad V	Vf	32	35.4	38	V
Forwrd A	If	-	270	600	mA
Power	Pi	-	9.5	22.8	W
Junction Temp	Tj	-	-	150	°C
Attractions (HBM)	-	-	-	8000	V
View Angle	2 θ1/2	-	120	-	Degrees
Operation Temperature	Top	-20	-	+85	°C
Storage Temperature	Tst	-40	-	+100	°C
Welding Temperature	Tsol	-	-	350	°C

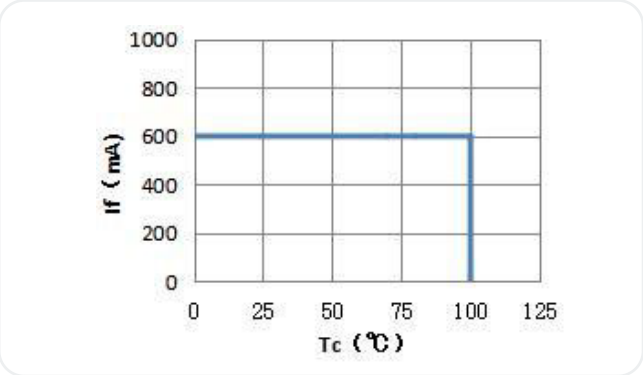
- Ta=25°C Bonding pad Tc≤85°C. In actual condition, silica gel surface temperature of ≤130°C

RELIABILITY TEST CURVE

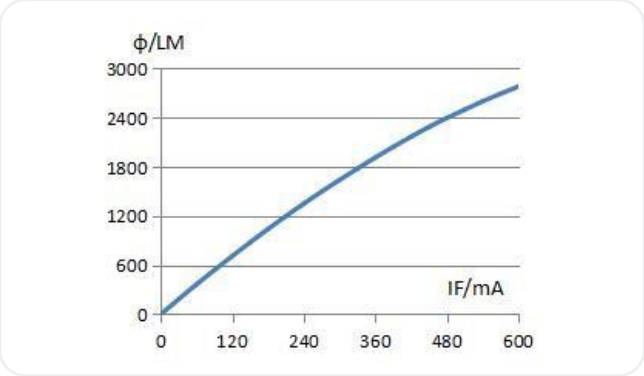
Temperature vs Lumen



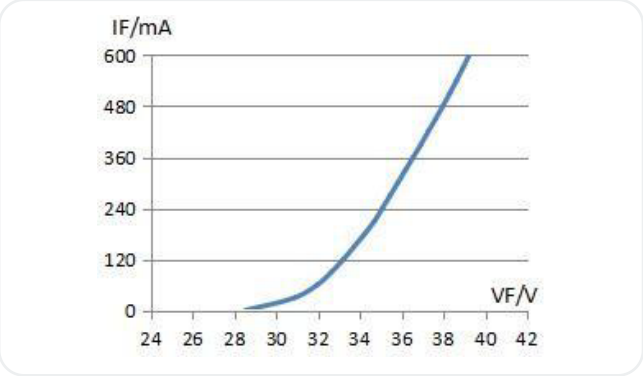
TCvs IF Curve



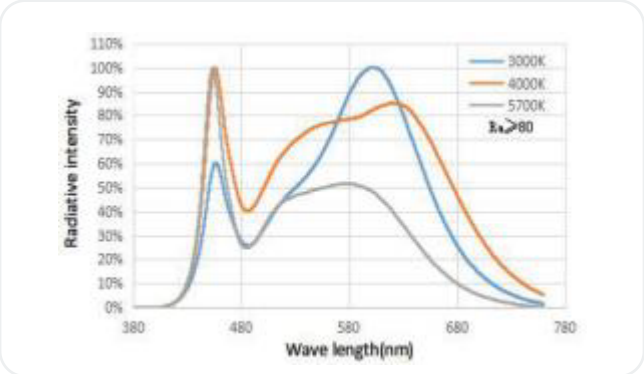
Current vs Lumen

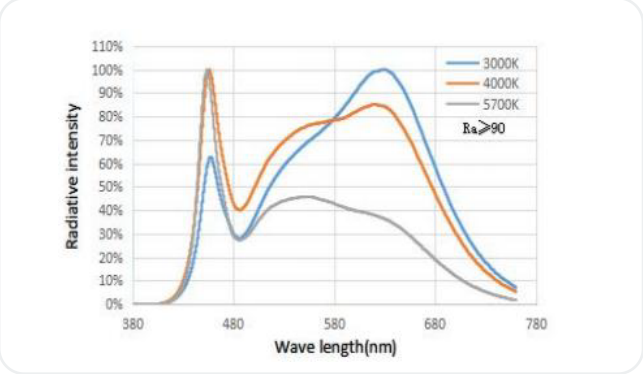


Voltage vs Curve

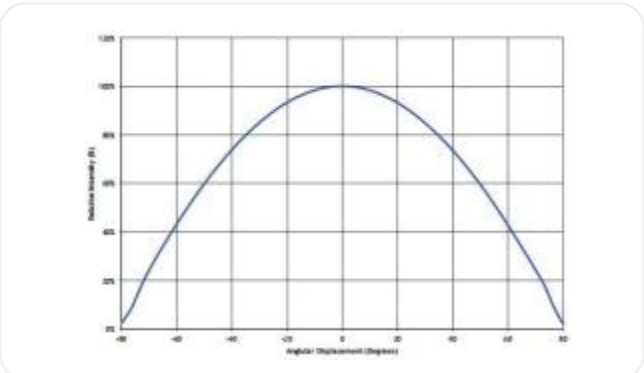


Relative Spectral Curve

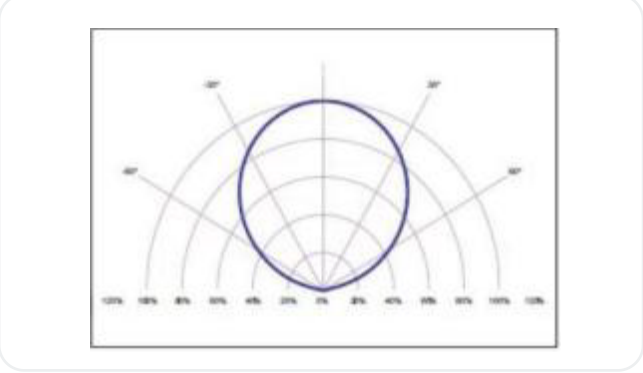




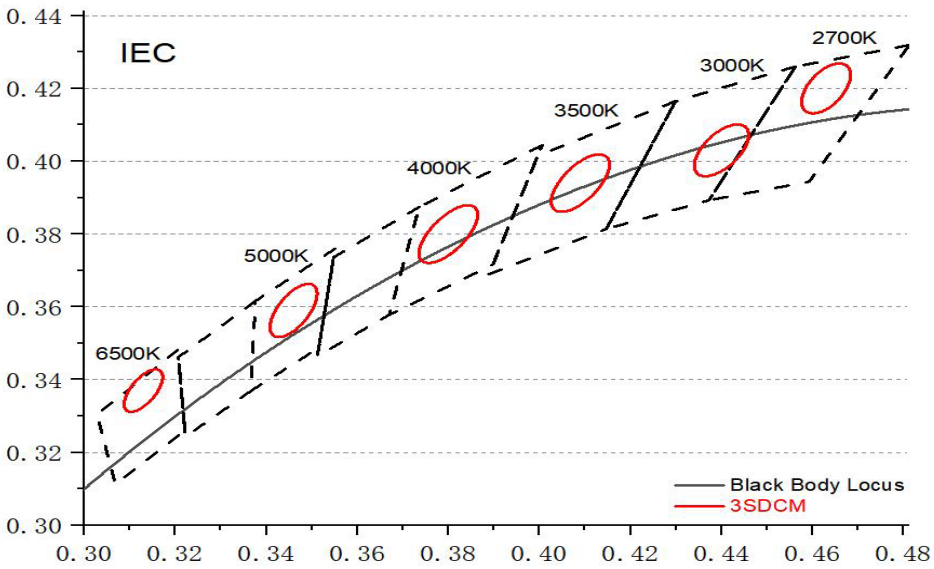
Light Distribution Diagram



Voltage vs Curve



White Bins On CIE-1931

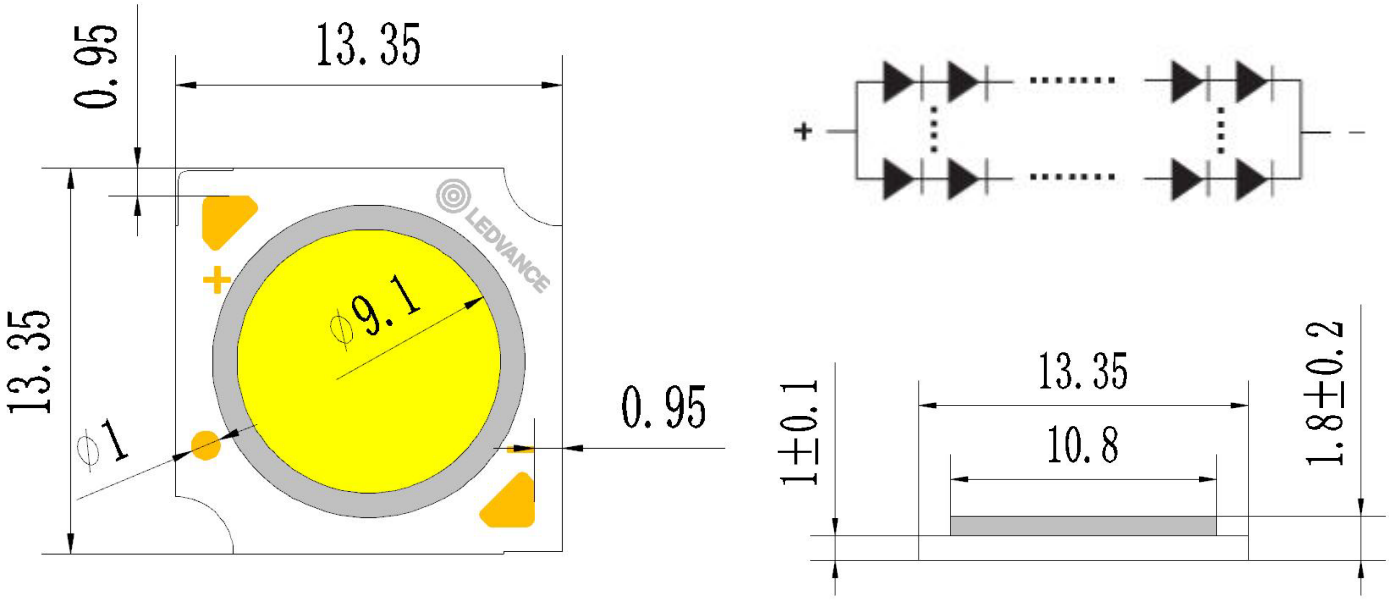


Color Temperature and BIN

CT	2700K	3000K	3500K	4000K	5000K	6500K
CT Range	2680-2790	2865-3015	3350-3550	3910-4160	4810-5160	6200-6700
CT Factor	±55	±75	±100	±125	±175	±250
Bin No	L627 E3	L630 E3	L635 E3	L640 E3	L650 E3	L665 E3

CCT	Chromaticity Tolerances	Central Point Coordinates		Long AxisA	Short AxisB	Rotation Angle
		X	Y			
2700K	3 SDCM	0.4630	0.4200	0.00258	0.00137	51.17
3000K	3 SDCM	0.4400	0.4030	0.00278	0.00136	53.10
3500K	3 SDCM	0.4090	0.3940	0.00317	0.00139	52.58
4000K	3 SDCM	0.3800	0.3800	0.00313	0.00134	54.00
5000K	3 SDCM	0.3460	0.3590	0.00274	0.00118	59.37
6500K	3 SDCM	0.3130	0.3370	0.00223	0.00095	58.23

MECHANICAL DIMENSION



ENCODING

LVCOB - PFM - 040 - 1206 - P4080

CRI: 70:70 CRI /. . ./ 90:90CRI

Kelvin: 30:3000K /. . ./ 65:6500K

P: Performance
V: Value

Series - Paralel Numbers
1206:1206 / 1208:1208 etc.

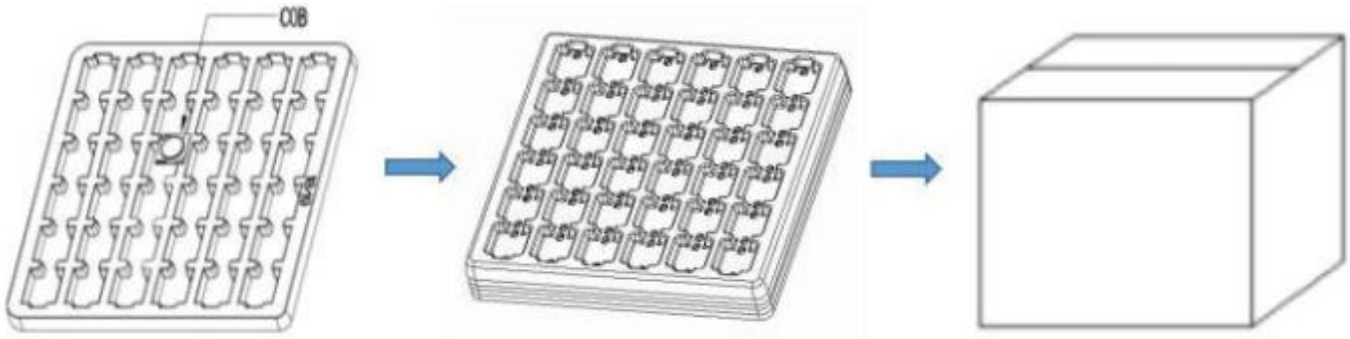
Watt: 40W - 040 / 50W - 050 / 54W - 054 etc.

Product Series: VAL - Value / PFM - Performance

Product Family: LEDVANCE COB

MANNER OF PACKING

COB Packing: Tray + Anti-static bag with vacuum packing + Outher boxes



Plastic Tray | Vacuum Bag Packing | Outer Boxes

Box Size	Lengh (cm)	Width (cm)	Height (cm)
Medium	30	30	24

PN Base	PCS/Tray	Tray/Bag	PCS/Bag	Bag/PCS/Medium Box
PFM-006-1202	60	5	300	12/3600
PFM-009-1203	60	5	300	12/3600
PFM-013-1204	60	5	300	12/3600
PFM-040-1206	40	5	200	12/2400
VAL-048-1207	40	5	200	12/2400
VAL-050-1208	40	5	200	12/2400

CAUTIONS

1. Storage

The storage environment humidity is <60%, the temperature is maintained at 20°C-30°C. Once the COB light sources have been unsealed, please install them within 168H; if it is not used up within 168H, please vacuum it and keep it sealed. After sealing, the effective use period is 1 year.

2. Application

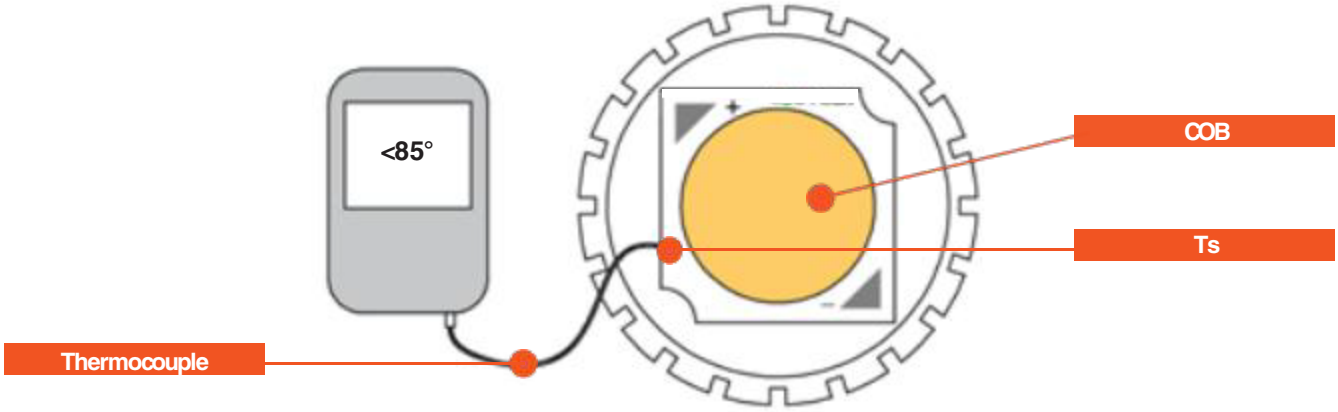
When welding, the soldering iron should be properly grounded. When manual welding, the temperature of the iron must be lower than 350°C, welding time shall not exceed 3 seconds and shall be cooled to room temperature before welding again. When welding, no external force should be put on the colloidal surface and the surrounding dam glue (such as pressure, friction or sharp metal nails, etc.) or it will cause deformation of gold wire or broken wire… In order to reduce the contact thermal resistance during assembling, please note that the thermal conductivity paste coating is uniform with proper distribution area , too little thermal conductivity paste or uneven application level is not okay. When using thermal conductive rubber pad, make sure that the base plate and thermal conductive rubber pad are in complete contact after screw installation,No hollow space is allowed. After welding, please do not let the heat conduction silicon grease, oil… to the luminous surface, dirt can be removed with an air gun, do not use sulfur, chlorine element liquid or washing board water to clean ,Air gun pressure: 0.5mpa, time 1-2 seconds, distance: more than 20cm apart. In order to prevent external substances from entering the interior of the LED and causing damage to the LED, the environment and kit used must have a single bromine element content of less than 900PPM, a single chlorine element content of less than 900PPM, a total bromine and chlorine element content of less than 1500PPM, and sulfur and
compound components must not exceed 100PPM.

3. Electrostatic Protection

This product is sensitive to static electricity, so effective protective measures must be taken when using this product to effectively prevent the damage of LED light source from static electricity and surge. When the high voltage current generated by static electricity exceeds the maximum rating of LED light source, the LED light source will be damaged or even completely invalid. Therefore, Customers should take effective measures to prevent static electricity and surge when using the products. Suggested grounding resistance is 10Ω or less.

4. Over-temperature, over current protection

Do not press the luminous silicon surface at any time to avoid bad effect or even ineffective to the COB. It is recommended to design grounding circuit for the whole lamp design.



The working humidity is between 50% and 80%, and the working environment is between -10°C and 85°C, otherwise, there will be hidden dangers of electrostatic breakdown and large current impact. When using this product, please ensure that it is used within the maximum rating (maximum current and Tc and glue surface temperature) specified in this specification. Any adverse consequences arising from failure to comply with the maximum rating and description of the product specifications shall not be covered by the warranty.

5. Thermal desing

A good use effect of LED light source depends on the thermal resistance of LED light source, external thermalresistance, power loss and ambient temperature.

High junction temperature of LED will affect the light flux and the working life of the light source. Full consideration of these factors is highly recommended in heat dissipation design.